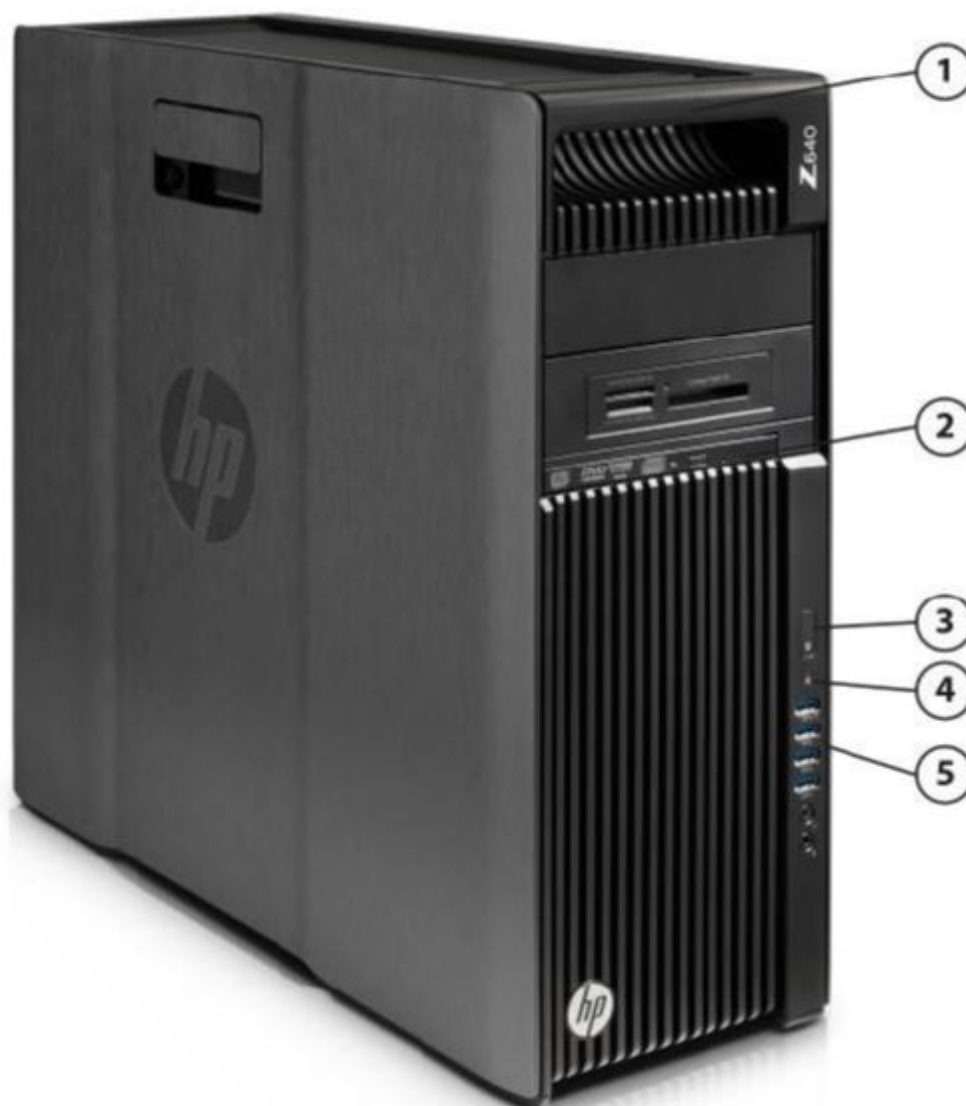


Overview



- | | |
|--------------------------------------|--|
| 1. Integrated Front Handle | 4. HDD Activity LED |
| 2. Dedicated 9.5mm Optical Drive Bay | 5. Front I/O=4 USB 3.0 with Charging Port (topmost port),
1 Microphone, 1 Headset |
| 3. Power Button | |

Overview



6.

2 External 5.25" Bays
7.

2 Internal 3.5" Bays
8.

6 6Gb/s SATA Ports
9.

Rear Flip-Up Handle
10.

925W, 90% Efficient Power Supply
11.

Rear I/O—Rear Power Button, 4 USB 3.0, 2 USB 2.0, PS/2 Ports, 1 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out
12.

Intel Xeon Processors—E5-1600 v3 family or E5-2600 v3 family
13.

4 DIMM Slots for DDR4 ECC Registered Memory
14.

2nd CPU and Memory Riser Module with 4 DIMM slots
15.

2 PCIe x16 Gen 3 Slots
16.

1 PCIe x8 Gen 3, 1 PCIe x1 Gen 2, 1 PCIe x4 Gen 2, 1 PCI Slot

Form Factor	Rackable Minitower
Operating Systems	Preinstalled— • Microsoft Windows 7 Professional (MSNA) 64-bit* • Microsoft Windows 8.1 Pro 64-bit* • Microsoft Windows 8.1 (China) 64-bit

Overview

- Microsoft Windows 8.1 Pro 64 downgrade to Windows 7 Professional 64-bit
- HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE Linux Enterprise Desktop 11)
- Red Hat® Enterprise Linux Desktop (Paper license with 1 year support; no preinstalled OS)

Notes—For detailed OS/hardware support information for Linux, see—
http://www.hp.com/support/linux_hardware_matrix

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper-Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology ¹	TDP (W)
Intel® Xeon® E5-1680 v3 processor	8	3.2	20	2133	—	YES	YES	3, 6	140
Intel Xeon E5-1660 v3 processor	8	3.0	20	2133	—	YES	YES	3, 5	85
Intel Xeon E5-1650 v3 processor	6	3.5	15	2133	—	YES	YES	1, 3	140
Intel Xeon E5-1630 v3 processor	4	3.7	10	2133	—	YES	YES	1, 1	140
Intel Xeon E5-1620 v3 processor	4	3.5	10	2133	—	YES	YES	1, 1	140
Intel Xeon E5-1607 v3 processor	4	3.1	10	1866	—	NO	YES	N/A	140
Intel Xeon E5-1603 v3 processor	4	2.8	10	1866	—	NO	YES	N/A	140
Intel Xeon E5-2699 v3 processor	18	2.3	45	2133	9.6	YES	YES	5, 13	145
Intel Xeon E5-2697 v3 processor	14	2.6	35	2133	9.6	YES	YES	5, 10	145
Intel Xeon E5-2695 v3 processor	14	2.3	35	2133	9.6	YES	YES	5, 10	120
Intel Xeon E5-2683 v3 processor	14	2.0	35	2133	9.6	YES	YES	5, 10	120
Intel Xeon E5-2690 v3 processor	12	2.6	30	2133	9.6	YES	YES	5, 9	135
Intel Xeon E5-2680 v3 processor	12	2.5	30	2133	9.6	YES	YES	4, 8	120
Intel Xeon E5-2670 v3 processor	12	2.3	30	2133	9.6	YES	YES	3, 8	120
Intel Xeon E5-2660 v3 processor	10	2.6	25	2133	9.6	YES	YES	3, 7	105
Intel Xeon E5-2650 v3 processor	10	2.3	25	2133	9.6	YES	YES	3, 7	105
Intel Xeon E5-2667 v3 processor	8	3.2	20	2133	9.6	YES	YES	2, 4	135
Intel Xeon E5-2640 v3 processor	8	2.6	20	1866	8.0	YES	YES	2, 8	90



Overview

Intel Xeon E5-2630 v3 processor	8	2.4	20	1866	8.0	YES	YES	2, 8	85
Intel Xeon E5-2643 v3 processor	6	3.4	20	2133	9.6	YES	YES	2, 3	135
Intel Xeon E5-2620 v3 processor	6	2.4	15	1866	8.0	YES	YES	2, 8	85
Intel Xeon E5-2609 v3 processor	6	1.9	15	1600	6.4	NO	YES	N/A	85
Intel Xeon E5-2603 v3 processor	6	1.6	15	1600	6.4	NO	YES	N/A	85
Intel Xeon E5-2637 v3 processor	4	3.5	15	2133	9.6	YES	YES	1, 2	135
Intel Xeon E5-2623 v3 processor	4	3.0	10	1866	8.0	YES	YES	3, 5	105
¹The specifications shown in this column represent the following²—(all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. NOTE²Z640 systems configured with an E5-1600 series processor may not add a 2nd processor. To support two processors, an E5-2600 series processor must be chosen.									
Available Processor Disclaimers	When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See² http://www.intel.com/products/processor_number/ for details. Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits²—check with software provider to determine suitability²—Not all customers or software applications will necessarily benefit from use of these technologies. 64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See² http://www.intel.com/info/em64t for more information.								
Color	Hematite Brushed Aluminum and HP Black								
Expansion Slots (see system board section for more details)	Slot 1 (top)² PCI Express Gen2 x1 with open-ended connector* Full-height, Half-length (Not available when 2nd processor/memory module is installed) Slot 2² PCI Express Gen3 x16 Full-height, Full-length (with extender) Slot 3² PCI Express Gen2 x4 with open-ended connector* Full-height, Full-length (with extender)								



Overview

	Slot 4⁺ PCI Express Gen3 x8 with open-ended connector* Full-height, Full-length (with extender)	
	Slot 5⁺ PCI Express Gen3 x16 Full-height, Full-length (with extender)	
	Slot 6⁺ PCI 32bit/33MHz Full-height, Full-length (with extender) * Open-ended connector allows a greater bandwidth (e.g., x16) card to be installed physically into a lower bandwidth connector/slot.	
Expansion Bays (see storage section for more details)	2 internal 3.5" bays (with acoustic dampening rail assemblies preinstalled) 2 external 5.25" bays • 3rd and 4th 3.5" HDD each occupy one external bay • 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2⁺1 carrier 1 dedicated 9.5mm slim optical disk drive bay	
Front I/O	4 USB 3.0, 1 Headset, 1 Microphone	
Internal I/O	1 USB 2.0 ports available by a 2x5 header. Each 2x5 header supports either one HP Internal USB Port Kit (EM165AA) or one 15-in-1 Media Card Reader. 1 USB 3.0 port available by a 2x10 header.	
Rear I/O	4 USB 3.0, 2 USB 2.0, 2 PS/2, 1 RJ-45 (NIC), 1 Audio Line-In, 1 Audio Line-Out. Serial supported with optional connector on PCI bracket cabled to system board connector.	
Internal USB	1 USB 2.0 port available by a 2x5 header. Each 2x5 headersupports either one HP Internal USB Port Kit (EM165AA) or one 15-in-1 Media Card Reader. 1 USB 3.0 port available by a 2x10 header.	
Chassis Dimensions (HxWxD)	17.5 x 6.75 x 18.3 in (44.45 x 17.15 x 46.48 cm) Rack utilization ⁺ 4U	
System Weight	Actual weight depends upon configuration Minimum configuration ⁺ 15.0 kg (33.1 lbs.) Typical configuration ⁺ 17.0 kg (37.5 lbs.) Maximum configuration ⁺ 21.8 kg (48.0 lbs.)	
Temperature	Operating ⁺	5° to 35°C (40° to 95°F)
	Non-operating	-40° to 60°C (-40° to 140°F)
Humidity	Operating ⁺	8% to 85% relative humidity, non-condensing
	Non-operating	8% to 90% relative humidity, non-condensing
Maximum Altitude (non-pressurized)	Operating ⁺	3,048m (10,000ft)
	Non-operating	9,144m (30,000ft)
Power Supply	Tool-free 925W 90% Efficient wide-ranging, active Power Factor Correction, with two graphics power cables The Power Supply Efficiency Report for this product may be found at this link ⁺ (TBD)	
Interfaces Supported	15-in-1 Media Card Reader (optional) 6-channel SATA interfaces (6 @ 6.0 Gb/s). 6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported). USB 2.0, USB 3.0	

Overview

Workstation ISV Certifications	See the latest list of certifications at http://www.hp.com/united-states/campaigns/workstations/partnerships.html
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Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel Xeon E5-1600 v3 Series CPU				
Intel Xeon E5-1680 v3 3.2 2133 8C CPU	Y	N		
Intel Xeon E5-1660 v3 3.0 2133 8C CPU	Y	N		
Intel Xeon E5-1650 v3 3.5 2133 6C CPU	Y	N		
Intel Xeon E5-1630 v3 3.7 2133 4C CPU	Y	N		
Intel Xeon E5-1620 v3 3.5 2133 4C CPU	Y	N		
Intel Xeon E5-1607 v3 3.1 1866 4C CPU	Y	N		
Intel Xeon E5-1603 v3 2.8 1866 4C CPU	Y	N		
Z640 Intel Xeon E5-2600 v3 Series CPU				
Xeon E5-2699 v3 2.3 2133 18C CPU	Y	Y	J9P85AA	
Xeon E5-2697 v3 2.6 2133 14C CPU	Y	Y	J9P86AA	
Xeon E5-2695 v3 2.3 2133 14C CPU	Y	Y	J9P87AA	
Xeon E5-2683 v3 2.0 2133 14C CPU	Y	Y	J9P90AA	
Xeon E5-2690 v3 2.6 2133 12C CPU	Y	Y	J9P88AA	
Xeon E5-2680 v3 2.5 2133 12C CPU	Y	Y	J9P91AA	
Xeon E5-2670 v3 2.3 2133 12C CPU	Y	Y	J9P92AA	
Xeon E5-2660 v3 2.6 2133 10C CPU	Y	Y	J9P94AA	
Xeon E5-2650 v3 2.3 2133 10C CPU	Y	Y	J9P95AA	
Xeon E5-2667 v3 3.2 2133 8C CPU	Y	Y	J9P89AA	
Xeon E5-2640 v3 2.6 1866 8C CPU	Y	Y	J9P97AA	
Xeon E5-2630 v3 2.4 1866 8C CPU	Y	Y	J9P98AA	
Xeon E5-2643 v3 3.4 2133 6C CPU	Y	Y	J9P93AA	
Xeon E5-2620 v3 2.4 1866 6C CPU	Y	Y	J9Q00AA	
Xeon E5-2609 v3 1.9 1600 6C CPU	Y	Y	J9Q01AA	
Xeon E5-2603 v3 1.6 1600 6C CPU	Y	Y	J9Q02AA	
Xeon E5-2637 v3 3.5 2133 4C CPU	Y	Y	J9P96AA	
Xeon E5-2623 v3 3.0 1866 4C CPU	Y	Y	J9P99AA	

Note 1—When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See http://www.intel.com/products/processor_number/ for details.

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits—check with software provider to determine suitability—Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary

Supported Components

depending on your hardware and software configurations. See <http://www.intel.com/info/em64t> for more information.

Z640 processor AMO kits include:

- 2nd CPU/Memory Module (riser)
- processor
- heatsink

First processor (CPU0) upgrades are not supported by HP.

Monitors / Displays

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Z Display Z30i 30-inch IPS LED Backlit Monitor				
HP Z Display Z27i 27-inch IPS LED Backlit Monitor				
HP Z Display Z24i 24-inch IPS LED Backlit Monitor				
HP Z Display Z23i 23-inch IPS LED Backlit Monitor				
HP Z Display Z22i 21.5-inch IPS LED Backlit Monitor				
HP DreamColor Z27x Professional Display				
HP DreamColor Z24x Professional Display				

Storage / Hard Drives

SAS Hard Drives

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
SAS Hard Drives for HP Workstations				
600GB SAS 15K rpm 6Gb/s 3.5" HDD	Y	Y	VM647AA	
300GB SAS 15K rpm 6Gb/s 3.5" HDD	Y	Y	LU967AA	
HP 1.2TB SAS 10K SFF HDD	Y	Y	E2P04AA	
HP 600GB SAS 10K SFF HDD	Y	Y	A2Z21AA	
HP 300GB SAS 10K SFF HDD	Y	Y	A2Z20AA	

NOTES:

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (4) 3.5-inch 15K rpm SAS drives=300, 600 GB±2.4 TB max

Up to (4) 2.5-inch 10K rpm SAS drives=300, 600 GB, 1.2 TB±4.8 TB max

SAS controller add-in card required

3rd and 4th SFF SAS HDDs will be automatically installed into a single 2.5" 5.25" external bay adapter

Removable Boot Drive option

SATA Hard Drives

SATA (Serial ATA) Hard Drives for HP Workstations

500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA
1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA



Supported Components

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA
3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QF298AA
500GB SATA 7.2K SED SFF HDD	Y	Y	D8N29AA

NOTES

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (4) 3.5-inch 7200 rpm SATA drives=500 GB, 1.0, 2.0, 3.0, 4.0* TB=16.0 TB max

Up to (1) 2.5-inch SATA Self-Encrypting Drive (SED)=500 GB Opal 1

Removable Boot Drive option

4TB drive planned to be available late 2014

SATA Solid State Drives (SSDs)

HP Solid State Drives (SSDs) for Workstations

HP 128GB SATA 6Gb/s SSD	Y	Y	A3D25AA
HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA
HP 512GB SATA 6Gb/s SSD	Y	Y	D8F30AA
HP 1TB SATA 6Gb/s SSD	Y	Y	F3C96AA
HP 256GB SATA 6Gb/s SED SSD	Y	Y	D8N28AA
Intel Pro 1500 180GB SATA SSD	Y	Y	F5Z70AA
Samsung Enterprise 240GB SATA SSD	Y	Y	F0W94AA
Samsung Enterprise 480GB SATA SSD	Y	Y	F0W95AA

NOTES

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (4) 2.5-inch 6Gb/s SATA Solid State Drives=128, 256, 512 GB, 1 TB=4.0 TB max

Up to (1) 2.5-inch 6Gb/s SATA Self-Encrypting Solid State Drive (SED SSD)=256 GB Opal 2

Up to (4) 2.5-inch Intel Pro 1500 6Gb/s SATA Solid State Drive=180 GB=720 GB max

Up to (4) 2.5-inch Samsung Enterprise 6Gb/s SATA Solid State Drives=240, 480 GB=1.9 TB max

3rd and 4th SSDs will be automatically installed into a single 2=1 5.25" external bay adapter

PCIe SSDs

PCIe SSDs for HP Workstations

HP Z Turbo Drive 512GB SSD	Y	Y	G3G89AA
HP Z Turbo Drive 256GB SSD	Y	Y	G3G88AA

NOTES

Up to (2) PCI Express Solid State Drives=256, 512 GB=1.0 TB max

PCIe SSDs are not available with SAS controller and/or SAS HDDs

Up to (2) PCI Express Solid State Drives=256, 512 GB=1.0 TB max

PCIe SSDs are not available with SAS controller and/or SAS HDDs

Supported Components

Hard Drive Controllers

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated SATA 6.0 Gb/s Controller				
Integrated SATA 6.0 Gb/s Controller	Y	N		Two ports
Factory integrated RAID on motherboard for SATA drives				
RAID 0 Configuration – Striped Array	Y	N		Note 1
RAID 1 Configuration – Mirrored Array	Y	N		Note 1
RAID 10 Configuration – Striped/Mirrored Array	Y	N		Note 1
RAID 0 Data Configuration -- Boot/OS Drive + 2 Drive Striped Array	Y	N		Note 1
LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card				
LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card	Y	Y	E0X20AA	
LSI 9270-8i SAS 6Gb/s ROC RAID Card and iBBU9 Battery Backup Unit				
LSI 9270-8i SAS 6Gb/s ROC RAID Card	Y	Y	E0X21AA	

SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://www.hp.com/support/linux_hardware_matrix for RAID capabilities with Linux.

All drives must be identical in type and capacity.

RAID arrays greater than 2 TB are fully supported.

NOTE 1—Requires hard drives with identical speed, capacity, and interface. Specific user-configured hardware SAS RAID configurations are supported on this Linux system. For details, please visit http://www.hp.com/support/linux_hardware_matrix

NOTE 2—Specific user-configured hardware SAS RAID configurations are supported on this

Linux system. IS=Striping of 2 or more HDDs into a single logical volume

IM=Mirroring of 2 HDDs into a single logical volume

IME=Mirroring of 3 or more HDDs into a single logical volume.

For details, please visit http://www.hp.com/support/linux_hardware_matrix

Supported Components

Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported # of cards	Mixed?
Professional 2D						
NVIDIA NVS 310 512MB Graphics	Y	Y	A7U59AA	Note 1, 2	4	—
NVIDIA NVS 315 1GB Graphics	Y	Y	E1U66AA	Note 2	4	—
NVIDIA NVS 510 2GB Graphics	Y	Y	C2J98AA	Note 1	2	—
Graphics Cable Adapters						
HP DisplayPort To DVI-D Adapter (4-Pack)	Y	N			1	—
HP DisplayPort To VGA Adapter 2nd	Y	N			1	—
HP DisplayPort To DVI-D Adapter (6-Pack)	Y	N			1	—
HP DisplayPort To DVI-D Adapter (2-Pack)	Y	N			1	—
HP DisplayPort to Dual Link DVI Adapter	Y	Y	NR078AA		1	—
HP DisplayPort To VGA Adapter	Y	Y	AS615AA		1	—
HP DisplayPort To DVI-D Adapter	Y	Y	FH973AA		1	
Entry 3D						
NVIDIA Quadro K620 2GB Graphics	Y	Y	J3G87AA		2	—
NVIDIA Quadro K420 1GB Graphics	Y	Y	J3G86AA		2	—
Mid-range 3D						
NVIDIA Quadro K2200 4GB Graphics	Y	Y	J3G88AA		2	—
AMD FirePro W2100 2GB Graphics	Y	Y	J3G91AA		2	—
AMD FirePro W5100 4GB Graphics	Y	Y	J3G92AA		2	—
High End 3D						
NVIDIA Quadro K4200 4GB Graphics	Y	Y	J3G89AA		2	—
NVIDIA Quadro K5200 8GB Graphics	Y	Y	J3G90AA		2	—
NVIDIA Quadro K6000 12GB Graphics	Y	Y	C2J96AA		1	No

NOTE 1—If 1st card is NVS 510, 2nd card must be NVS 510 or NVS 310.

NOTE 2—4th NVS 310 or NVS 315 supported as AMO-only

Supported Components

High Performance GPU Computing

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
NVIDIA Tesla K40 Workstation Coprocessor	Y	Y	F4A88AA	Note 1
NVIDIA Tesla K20c Compute Processor	Y	Y	C2J97AA	Note 2

NOTE 1—Tesla K40 is supported with QK5200, QK620 or QK2200.

Not supported with 2 graphics cards.

Not supported with OS WIN7 32-bit.

Not supported with OS WIN8.0.

NOTE 2—Tesla K20 is supported in combination with NVIDIA Quadro K620/K2200/K4200 1st graphics. Not supported with Win7 32-bit OS.

Memory

CTO

DDR4-2133 ECC Registered DIMMs

	Option Kit Part Number	Support Notes
4GB DDR4-2133 ECC Registered RAM	J9P81AA	1,2
8GB DDR4-2133 ECC Registered RAM	J9P82AA	1,2
16GB DDR4-2133 ECC Registered RAM	J9P83AA	1,2
32GB DDR4-2133 ECC Load Reduced (LR) RAM	J9P84AA	1,2

NOTES

For details on the supported memory configurations on the HP Z640 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 4 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

With single-processor configurations, 4 DIMM slots are available. 4 additional DIMM slots are available with the 2nd CPU & Memory Module.

The CPUs determine the speed at which the memory is clocked. If an 1866MHz capable CPU is used in the system, the maximum speed the memory will run at is 1866MHz, regardless of the specified speed of the memory.

ONLY registered and load reduced DDR4 DIMMs are supported.
DDR3 DIMMs ARE NOT SUPPORTED.

Multimedia and Audio Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Realtek HD ALC221 Audio	Y	N		

Supported Components

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives				
HP 9.5mm Slim SuperMulti DVD Writer	Y	Y	K3R64AA	
HP 9.5mm Slim DVD-ROM Drive	Y	Y	K3R63AA	Note 1
HP 9.5mm Slim BDXL Blu-Ray Writer	Y	Y	K3R65AA	Note 2
HP DX115 Removable Drive Enclosure				
HP DX115 Removable HDD Carrier	N	Y	NB792AA	
HP DX115 Removable HDD Frame/Carrier	N	Y	FZ576AA	
HP 15-in-1 Media Card Reader				
HP 15-in-1 Media Card Reader	Y	Y	G1S79AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1 Not supported as a 2nd Optical Drive.

NOTE 2 Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP IEEE 1394b FireWire® PCIe Card	Y	Y	NK653AA	
HP Thunderbolt™ 2 PCIe 1-port I/O Card	Y	Y	F3F43AA	Note 1

NOTE 1 Compatible with NVIDIA Quadro K620, K2200, K4200, and K5200 only.

Supported Components

Networking and Communications

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Intel I218LM PCIe GbE Controller	Y	N		
Intel Ethernet I210-T1 PCIe NIC	Y	Y	E0X95AA	
HP X520 10GbE Dual Port Adapter	Y	Y	C3N52AA	
HP 10GbE SFP+ SR Transceiver	Y	Y	C3N53AA	
HP 361T PCIe Dual Port Gigabit NIC	N	Y	C3N37AA	Note 1
Intel 7260 802.11 a/b/g/n PCIe WLAN NIC*	Y	Y	F2P07AA	

NOTE 1: Gigabit Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

*Wireless access point and internet service required. Availability of public wireless access points limited.

Racking and Physical Security

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Solenoid Hood Lock & Hood Sensor	Y	N		
HP Business PC Security Lock Kit	N	Y	PV606AA	
HP Z6/8 Adjustable Rail Rack Kit, Flush Mount	N	Y	B8S55AA	

Input Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP PS/2 Keyboard	Y	Y	QY774AA	
HP USB Keyboard	Y	Y	QY776AA	
HP USB Smart Card Keyboard	Y	Y	E6D77AA	
HP Wireless Keyboard and Mouse	Y	Y	QY449AA	
HP PS/2 Mouse	Y	Y	QY775AA	
HP USB Optical Mouse	Y	Y	QY777AA	
HP USB 1000dpi Laser Mouse	Y	Y	QY778AA	
HP USB Optical 3-Button 2.9M OEM Mouse	Y	Y	ET424AA	
HP SpaceMouse Pro USB 3D Input Device	N	Y	B4A20AA	
HP SpacePilot Pro 3D USB Intelligent Controller	N	Y	WH343AA	

Supported Components

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Internal USB Port Kit	N	Y	EM165AA	Note 1
HP eSATA PCI Cable Kit	Y	Y	GM110AA	Note 2
HP Serial Port Adapter	Y	Y	PA716A	
HP Optical Bay HDD Mounting Bracket	N	Y	NQ099AA	
HP Power Cord Kit	N	Y	DM293A	
HP Workstation Mouse Pad	Y	N		Japan only
HP ENERGY STAR® Enabled Configuration	Y	N		

Note 1—The HP Internal USB Port kit has a single USB 2.0 type A connector.

Note 2—No hot plug / hot swap supported

Software

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Performance Advisor	Y	Y		Note 1
HP Remote Graphics Software (RGS) 6.0	Y	Y		Note 2
MS Office Home & Business 2013	Y	N		Note 3
Cyberlink Media Suite & PowerDVD	Y	N		
Foxit PhantomPDF Express	Y	N		Media playback/ authoring software

NOTE 1—Available as a free download here—<http://www.hp.com/go/performanceadvisor>

NOTE 2—Supported operating systems—

- Windows 7 Professional 32/64
- Windows 8 Professional 32/64
- RHEL v6.5
- SLED 11 SP3

For more information, go to—<http://www.hp.com/go/rgs>

NOTE 3—Must select as a Configure to Order option.

Supported Components

Operating Systems	Support Notes
Windows 8.1 Pro 64-bit	
Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit	
Windows 7 Professional (MSNA) 64-Bit	(National Academic)
HP Linux Installer Kit	
Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	Note 1

NOTE 1 - This second OS must be ordered with the HP Linux Installer Kit as the first OS.

System Technical Specifications

System Board

System Board Form Factor	Main System Board ⁻ 24 x 31 cm 9.6 x 12.2 inches 2nd CPU/Memory Board (optional) ⁻ 14.9 x 29.2 cm 5.85 x 11.50 inches
Processor Socket	LGA2011R3 1st CPU on system board 2nd CPU on optional 2nd CPU/Memory Module
CPU Bus Speed	QPI ⁻ Up to 9.6GT/second, depending on processor
Chipset	Intel® C612 Chipset
Super I/O Controller	Nuvoton NPCD379H (SIO-12)
Memory Expansion Slots	4 on system board(CPU0) + 4 on optional 2nd CPU/Memory Module(CPU1)
Memory Type Supported	DDR4, RDIMM (Registered), ECC ⁻ 4GB, 8GB and 16GB DDR4, LRDIMM (Load Reduced), ECC ⁻ 32GB
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	1600MHz, 1866MHz and 2133MHz

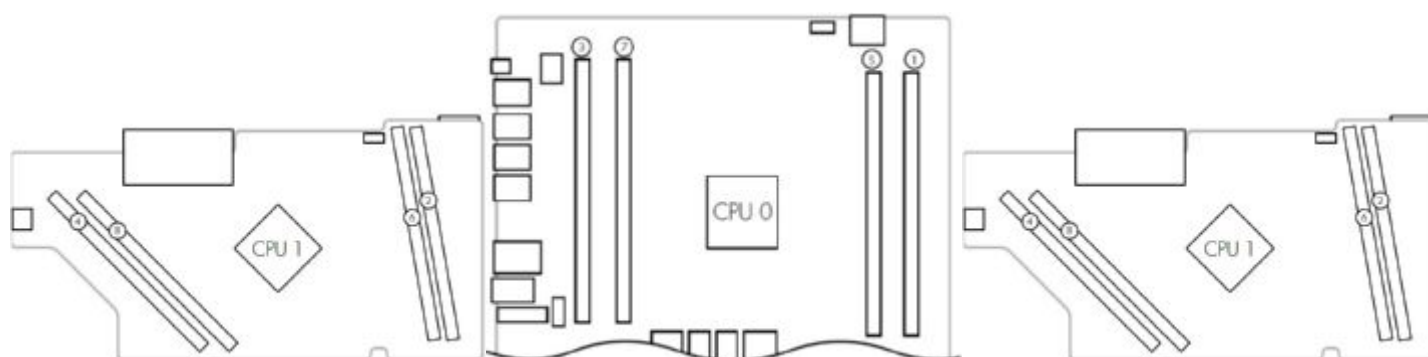
Single Processor

		CPU0				
	Notes	DIMM1	DIMM3	DIMM6	DIMM8	Rating
4GB	*	4GB				Fair
8GB		4GB 8GB			4GB	Good Fair
12GB		4GB	4GB		4GB	Better
16GB		4GB 8GB	4GB	4GB	4GB 8GB	Best Good
24GB	~	8GB	4GB	4GB	8GB	Better
32GB		8GB 16GB	8GB	8GB	8GB 16GB	Best Good
48GB	~	16GB	8GB	8GB	16GB	Better
64GB		16GB 32GB	16GB	16GB	16GB 32GB	Best Good
128GB		32GB	32GB	32GB	32GB	Best

System Technical Specifications

Dual Processor										
CPU0						CPU1				
	Notes	DIMM1	DIMM3	DIMM6	DIMM8	DIMM1	DIMM3	DIMM6	DIMM8	Rating
8GB		4GB				4GB				Fair
16GB		4GB 8GB			4GB	4GB 8GB			4GB	Good Fair
32GB	~	4GB 8GB 16GB	4GB	4GB	4GB 8GB	4GB 8GB 16GB	4GB	4GB	4GB 8GB	Best Good Fair
48GB	~	8GB	4GB	4GB	8GB	8GB	4GB	4GB	8GB	Better
64GB		8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	Best
96GB		16GB	8GB	8GB	16GB	16GB	8GB	8GB	16GB	Better
128GB		16GB 32GB	16GB	16GB	16GB 32GB	16GB 32GB	16GB	16GB	16GB 32GB	Best Good
256GB		32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	Best

Memory Loading Order=



Maximum Memory

Supports up to 256GB with two processors

Memory Configuration (Supported)

- Not all memory configurations possible are represented above.
- Only Registered and LR ECC DIMMs are supported.
- Do not install memory modules into memory slots if corresponding processor is not installed.
- Dual processor configurations with memory modules installed for only one processor is not supported.
- RDIMM (Registered) and LRDIMM (Load Reduced) memory cannot be mixed. All memory installed in the system must be either RDIMM or LRDIMM.

PCI Express Connectors

Slot 1 (top)=

PCI Express Gen2 x1 with open-ended connector*
Full-height, Half-length
(not available when 2nd CPU/Memory Module is installed)

Slot 2=

PCI Express Gen3 x16
Full-height, Full-length (with extender)

Slot 3=

System Technical Specifications

	PCI Express Gen2 x4 with open-ended connector* Full-height, Full-length (with extender) Slot 4 PCI Express Gen3 x8 with open-ended connector* Full-height, Full-length (with extender) Slot 5 PCI Express Gen3 x16 Full-height, Full-length (with extender) * Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot	
PCI Connectors (5.0V)	Slot 6 PCI 32bit/33MHz Full-height, Full-length (with extender)	
Supported Drive Interfaces	SATA	2 SATA @6Gb/s, supports RAID 0, 1 and NCQ. 4 sSATA @6Gb/s, Supports RAID 0,1,10 and NCQ. Factory integrated RAID is Microsoft Windows only.
	Serial Attached SCSI	Requires Optional PCIe card
Integrated RAID	SATA=RAID 0, 1 SSATA=RAID 0, 1, 10 RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array. *HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead	
Integrated Graphics	No	
Network Controller	Integrated Intel I-218 Gbit LAN Memory Integrated 3KB receive buffer and 3KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.1as, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i 802.3u, 802.3x, 802.3z Bus architecture PCIe 1.0 x1 and SMBus Power requirement 0.5 watts Boot ROM support Network transfer rates= 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s 100BASE-TX (full-duplex) 200 Mb/s Management capabilities=WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, Advanced cable diagnostics. AMT 9.1 support, vPro compliant	
SATA Connectors	Supported on all SATA and sSATA ports configurable with optional eSATA* After-Market Option cable kit) * hot plug / hot swap not supported with eSATA	

System Technical Specifications

IEEE 1394 Connector(s)	Front	None
	Rear	2 IEEE 1394b (requires optional PCIe card)
	Internal	None
USB Connector(s)	Front	4 - USB 3.0
	Rear	4 - USB 3.0 2 - USB 2.0
	Internal	One 2x5 header with two USB 2.0 ports. One 2x10 header with one USB 3.0 and one USB 2.0 port. Supports either one HP Internal USB Port Kit or one USB Media Card Reader. Each Internal Port Kit has one USB 2.0 connector.
HD Integrated Audio	Realtek ALC221	
Flash ROM	Yes	
CPU Fan Header	One for each CPU socket	
Chassis Fan Header	Rear System Chassis Fan Header Front System Chassis Fan Header	
CMOS Battery Holder - Lithium	Yes	
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header	Yes (includes speaker and intrusion sensor signals)	
Clear Password Jumper	Yes	
Serial Port	One internal header	
Parallel Port	No	
Keyboard/Mouse	PS/2	

Z640 Required Power Supply Info

Power Supply	925W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)	
Operating Voltage Range	90–269 VAC	
Rated Voltage Range	100–240 VAC	118 VAC
Rated Line Frequency	50–60 Hz	400 Hz
Operating Line Frequency Range	47–66 Hz	393–407 Hz
Rated Input Current	11.3 A @ 100–240 V	11.3 A @ 400 V
Heat Dissipation (Configuration and software dependent)	Typical = 2105 btu/hr (530 kcal/hr) Maximum = 3629 btu/hr (914 kcal/hr)	
Power Supply Fan	92x25 mm variable speed	
ENERGY STAR Qualified (Configuration dependent)	Yes	
80 PLUS® Compliant	Yes, 90% Efficient The Z640 925W power supply efficiency report can be found at this link-TBD	
FEMP Standby Power Compliant @115V (<2W in S5 - Power Off)	Yes	

System Technical Specifications

EuP Compliant @ 230V (<0.5 W in S5 - Power Off)	Yes
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)	Yes³Configuration dependent
Power Consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3) (Instantly Available PC)	<20W
Built-in Self Test LED	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes

Access Panel Solenoid Lock Header	Yes
Access Panel Intrusion	Yes
Sensor Header	Integrated in Front User Interface (Power Switch, Power LED, HDD LED, Speaker) Cable
Multibay Header	No
Integrated Gigabit Ethernet	Integrated Intel I-218 Gbit LAN
Wake on LAN	Yes
ASF 1.0/2.0 (Alert Standard Format)	No
TPM	Infineon TPM 1.2 Certified
Password Clear Header	Yes
AUX IN (audio)	No
Clear CMOS Button	Yes
Memory Fan Header	CPU0 Memory Fan Header³CPU1 Memory Fan Header

SYSTEM CONFIGURATION

System Technical Specifications

Example Z640 Configuration #1 ENERGY STAR QUALIFIED	Processor	1x Intel Xeon E5-1603 v3 (Quad-core)					
	Memory	1x 4GB DDR4-2133 (Registered DIMM)					
	Graphics	1x NVIDIA NVS 310					
	Disks/Optical	1x 500GB SATA 7200 71x Slim DVD-ROM SATA					
	Power Supply	925W 90% Custom PSU					
	Other	N/A					
Energy Consumption		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	56.68 W		55.98 W		55.96 W	
	Windows Busy Typ (S0)	110.76 W		106.57 W		110.89 W	
	Windows Busy Max (S0)	114.16 W		112.25 W		114.16 W	
	Sleep (S3)	2.26 W	2.16 W	2.49 W	2.39 W	2.25 W	2.15 W
	Off (S5)	0.924 W	0.805 W	1.02 W	0.992 W	0.815 W	0.792 W
	Zero Power Mode (ErP)	0.203 W		0.388 W		0.201 W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	193.39 btu/hr		191.00 btu/hr		190.94 btu/hr	
	Windows Busy Typ (S0)	377.91 btu/hr		363.61 btu/hr		378.36 btu/hr	
	Windows Busy Max (S0)	389.51 btu/hr		383.00 btu/hr		389.51 btu/hr	
	Sleep (S3)	7.72 btu/hr	7.37 btu/hr	8.51 btu/hr	8.17 btu/hr	7.69 btu/hr	7.33 btu/hr
	Off (S5)	3.15 btu/hr	2.75 btu/hr	3.48 btu/hr	3.38 btu/hr	2.78 btu/hr	2.70 btu/hr
	Zero Power Mode (ErP)	0.695 btu/hr		1.325 btu/hr		0.668 btu/hr	

Example Z640 Configuration #2	Processor	2x Intel Xeon E5-2643 v3 (Dual Six-core)					
	Memory	8x 8GB DDR4-2133 (Registered DIMM)					
	Graphics	1x NVIDIA Quadro K5200					
	Disks/Optical	4x 2TB SATA 7200 71x Slim SuperMulti DVDRW SATA					
	Power Supply	925W 90% Custom PSU					
	Other	N/A					
Energy Consumption		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	82.62 W		82.36 W		83.10 W	
	Windows Busy Typ (S0)	399.09 W		397.52 W		399.46 W	
	Windows Busy Max (S0)	497.57 W		495.56 W		492.48 W	
	Sleep (S3)	4.718 W	4.612 W	4.864 W	4.759 W	4.699 W	4.581 W
	Off (S5)	0.992 W	0.813 W	1.042 W	0.988 W	0.823 W	0.793 W
	Zero Power Mode (ErP)	0.204 W		0.384 W		0.202 W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	281.90 btu/hr		281.01 btu/hr		283.54 btu/hr	
	Windows Busy Typ (S0)	1361.70 btu/hr		1356.34 btu/hr		1362.95 btu/hr	
	Windows Busy Max (S0)	1697.71 btu/hr		1690.85 btu/hr		1680.34 btu/hr	
	Sleep (S3)	16.09 btu/hr	15.74 btu/hr	16.60 btu/hr	16.24 btu/hr	16.03 btu/hr	15.63 btu/hr
	Off (S5)	3.15 btu/hr	2.77 btu/hr	3.56 btu/hr	3.37 btu/hr	2.81 btu/hr	2.71 btu/hr
	Zero Power Mode (ErP)	0.694 btu/hr		1.311 btu/hr		0.689 btu/hr	

System Technical Specifications

DECLARED NOISE EMISSIONS

System Configuration (Entry level)	Processor Info	1x Intel Xeon E5-2650 v3 2.30 GHz
	Memory Info	2x 8 GB DDR4-2133 MHz RDIMM
	Graphics Info	1x NVIDIA NVS 310
	Disks/Optical/Floppy	1x 1 TB SATA 7200 RPM 1x Blu-ray DVD-RW

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.3	16
	Hard drive Operating (random reads)	3.5	17
	DVD-ROM Operating (sequential reads)	4.5	31

System Configuration (High-end)	Processor Info	2x Intel Xeon E5-2697 v3 2.60 GHz
	Memory Info	8x 16 GB DDR4-2133 MHz RDIMM
	Graphics Info	1x NVIDIA Quadro K4200
	Disks/Optical/Floppy	2x 600 GB SAS 15K RPM 3.5" HDD 1x Blu-ray DVD-RW

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	4.4	27
	Hard drive Operating (random reads)	4.8	29
	DVD-ROM Operating (sequential reads)	4.7	31

ENVIRONMENTAL DATA

System Technical Specifications

Environmental Requirements	Temperature	Operating -5° to 35° C (40° to 95° F) Non-operating -40° to 60° C (-40° to 140° F)
	Humidity	Operating -8% to 85% RH, non-condensing Non-operating -8% to 90% RH, non-condensing
	Maximum Altitude	Operating -3,000 m (10,000 feet) Non-operating -9,100 m (30,000 feet)
	Dynamic (new)	Shock Operating -½-sine -40g, 2-3ms (~62 cm/sec) Non-operating -½-sine -160 cm/s, 2-3ms (~105g) square -20 g, 422 cm/s NOTE - Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random -0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random -2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE - Values do not indicate continuous vibration.
	Cooling	Above 1524m (5,000 ft.) altitude, maximum operating temperature is de-rated by 1°C (1.8°F) per 305m (1,000 ft.) elevation increase

Physical Security and Serviceability

Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less Integrated blind-mate drive carriers Optional 5.25" external bay carriers
Expansion Cards	Tool-less
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.
Green User Touch Points	Yes, on primary serviceable components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less 2nd CPU/Memory Module - Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image - Can be obtained via HP Support.
Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.

System Technical Specifications

Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional)–Prevents entire system theft only. 3mm x 7mm slot at rear of system
Universal Chassis Clamp Lock Support	No
Solenoid Lock and Hood Sensor	Access Panel Solenoid Lock–Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor–Yes (optional).
Rear Port Control Cover	No
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.
Power-On Password	Yes, prevents an unauthorized person from booting up the computer.
Setup Password	Yes, prevents an unauthorized person from changing the system configuration.
3.3V Aux Power LED on System PCA	Yes
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	CPU heatsink removal requires a T-15 Torx or flat blade screwdriver. CPU removal is tool-less.
Power Supply Diagnostic LED	Yes
Front Power Button	Yes
Rear Power Button	Yes
Front Power LED	Yes, white (normal), red (fault)
Front Hard Drive Activity LED	Yes, green
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM	Recovers corrupted system BIOS
Flash Recovery	
Cooling Solutions	Air cooled forced convection
Power Supply Fans	1 - 92mm
CPU Heatsink Fan	1st CPU–1 - 92mm Optional 2nd CPU–1 - 92mm
Memory Heatsink Fan	Optional 2nd CPU/Memory Module–rear bank–1 - 80mm.
HP Advanced System Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to– • Run diagnostics • View the hardware configuration of the system Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the

System Technical Specifications

	system. Vision diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are— • Testing and diagnosing apparent hardware failures • Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance • Sending configuration information to another location for more in-depth analysis • Entered using F2
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including devices installed in the external 5.25" bays.
Trusted Platform Module Chip	Yes, Infineon TPM 1.2 Certified
Integrated Chassis Handles	Yes
Power Supply	Tool-less. Includes integrated handle.
PCI Card Retention	Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender)\
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes

BIOS

BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot
BIOS Power On	Users can define a specific date and time for the system to power on
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM

System Technical Specifications

Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.7 for system management information
Boot Control	Disables the ability to boot from removable media on supported devices
Memory Change Alert	Alerts management console if memory is removed or changed
Thermal Alert	Monitors the temperature state within the chassis. Three modes— • NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen
Remote Wakeup/ Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing
Auto Setup when new hardware installed	System automatically detects the addition of new hardware
Keyboard-less Operation	The system can be booted without a keyboard
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memory
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED

System Technical Specifications

Industry Standard Specification Support	
UEFI Specification Revision	2.3.1
Industry Standard Revision	Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 2.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	- PCI Local Bus Specification, Revision 2.3 - PCI Power Management Specification, Revision 1.1 - PCI Firmware Specification, Revision 3.0, Draft 0.7
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATA 3 Gb/s—Serial ATA Specification, Revision 2.5 - Serial ATA 6 Gb/s—Serial ATA Specification, Revision 3.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.7

External BIOS simulator found at—<http://h20464.www2.hp.com/index.html>

Social and Environmental Responsibility

Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks— - ENERGY STAR® (energy-saving features available on selected configurations—Windows only) - US Federal Energy Management Program (FEMP) - China Energy Conservation Program - The ECO declaration (TED)
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size—CR2032 (coin cell) Battery type—Lithium Metal The battery in this product does not contain—



System Technical Specifications

	- Mercury greater than 5ppm by weight - Cadmium greater than 10ppm by weight - Lead greater than 40ppm by weight
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.
Low Halogen Statement	This product is low-halogen except for power cords, external cables and peripherals. The following customer-configurable internal components may not be low-halogen: 3 ½" SAS HDDs, LSI 9270-8i SAS ROC RAID Card, and LSI 9217-4i4e SAS ROC RAID Card. Service parts obtained after purchase may not be low-halogen.
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Additional Information	- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. http://www.hp.com/hpinfo/globalcitizenship/environment/productdata/disassemblyworkstatio.html - Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. - EPEAT Gold - ENERGY STAR qualified configurations of this product are in compliance with the IEEE 1680 (EPEAT) standard at the Gold level where HP registers workstation products. See http://www.epeat.net/CompanyDetail.aspx?CompanyID=24 for registration status in your country.
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html - Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment - Does not contain ozone-depleting substances (ODS) - Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed - Maximizes the use of post-consumer recycled content materials in packaging materials - All packaging material is recyclable - All packaging material is designed for ease of disassembly - Reduced size and weight of packages to improve transportation fuel efficiency - Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting
Packaging Materials	
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).
External	Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability



System Technical Specifications

Industry Standard Specifications	This product meets the following industry standard specifications for manageability functionality¹ • DASH 1.1 (via Intel® LAN on motherboard)
Intel Active Management Technology (AMT)	Intel® Active Management Technology (AMT) 9.1 An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.1 includes the following advanced management functions² • Power Management (on, off, reset, graceful shutdown, sleep and hibernate) • Support in Max Power Savings (Shutdown and Hibernate Modes) • Hardware Inventory (includes BIOS and firmware revisions) • Hardware Alerting • Agent Presence • System Defense Filters • Serial Over LAN (SOL) • IDE Redirect • ME Wake-on-LAN (WOL) • DASH 1.1 compliance • IPv6 Support • Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection • Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. • Remote Alerts - automatically alert IT or service provider if issues arise • Access Monitor - Provides oversight into Intel® AMT actions to support security requirements • PC Alarm Clock • Microsoft NAP Support • Host Base set-up and configuration • Management Engine (ME) firmware roll back • Local Time Sync to UTC • Remote Memory Dump Command - Creates memory dump for debug
Intel® vPro™ Technology	The HP Z640 Workstation supports Intel® vPro™ technology when configured as outlined below³ • Intel® Xeon® processor E5-1600 v3 product family or E5-2600 v3 product family featuring Intel® vPro™ Technology • Intel® C612 chipset • Intel® I218LM GbE LAN
Remote Manageability Software Solutions	The HP Z640 Workstation is supported on the following remote manageability software consoles⁴ • LANDesk Management Suite (HP recommended solution) • Microsoft System Center Configuration Manager • HP Client Automation Enterprise For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy
System Software Manager	For questions or support for SSM, please visit http://www.hp.com/go/ssm
Service, Support, and Warranty	On-site Warranty and Service (Note 1)⁵ Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. NOTE 1 Terms and conditions may vary by country. Certain restrictions and exclusions apply.



System Technical Specifications

	NOTE 2 On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3 Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.
Product Change Notification	• Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. • PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. • Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of components designed and tested to work with HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors

Product #	Offering
J6F20AV	Intel Xeon E5-1620 v3 3.5GHz 4-core 10MB 2133
J6F31AV	Intel Xeon E5-2643 v3 3.4GHz 6-core 20MB 2133 1st
J6F49AV	Intel Xeon E5-2643 v3 3.4GHz 6-core 20MB 2133 2nd
J6F38AV	Intel Xeon E5-2620 v3 2.4GHz 6-core 15MB 1866 1st
J6F56AV	Intel Xeon E5-2620 v3 2.4GHz 6-core 15MB 1866 2nd
J6F36AV	Intel Xeon E5-2630 v3 2.4GHz 8-core 20MB 1866 1st
J6F54AV	Intel Xeon E5-2630 v3 2.4GHz 8-core 20MB 1866 2nd

Hard Drives

Product #	Offering
J3J74AV	500GB 7200 RPM SATA 1st Hard Disk Drive
J3J95AV	500GB 7200 RPM SATA 2nd Hard Disk Drive
J3K16AV	500GB 7200 RPM SATA 3rd Hard Disk Drive
J3K36AV	500GB 7200 RPM SATA 4th Hard Disk Drive
J3J75AV	1TB 7200 RPM SATA 1st Hard Disk Drive
J3J96AV	1TB 7200 RPM SATA 2nd Hard Disk Drive
J3K17AV	1TB 7200 RPM SATA 3rd Hard Disk Drive
J3K37AV	1TB 7200 RPM SATA 4th Hard Disk Drive

Graphics

Product #	Offering
J1P91AV	NVIDIA NVS 510 2GB 1st Graphics
J1Q03AV	NVIDIA NVS 510 2GB 2nd Graphics
J1P93AV	NVIDIA Quadro K620 2GB 1st Graphics
J1Q05AV	NVIDIA Quadro K620 2GB 2nd Graphics
J1P94AV	NVIDIA Quadro K2200 4GB 1st Graphics
J1Q06AV	NVIDIA Quadro K2200 4GB 2nd Graphics
J1P98AV	AMD FirePro W2100 2GB 1st Graphics
J1Q09AV	AMD FirePro W2100 2GB 2nd Graphics

Memory

Product #	Offering
G8X26AV	8GB DDR4-2133 (1x8GB) Registered RAM 1CPU
G8X30AV	16GB DDR4-2133 (2x8GB) Registered RAM 1CPU
G8X37AV	16GB DDR4-2133 (2x8GB) Registered RAM 2CPU



Stable & Consistent Offerings

G8X31AV	32GB DDR4-2133 (4x8GB) Registered RAM 1CPU
G8X38AV	32GB DDR4-2133 (4x8GB) Registered RAM 2CPU
G8X41AV	64GB DDR4-2133 (8x8GB) Registered RAM 2CPU
G8X32AV	32GB DDR4-2133 (2x16GB) Registered RAM 1CPU
G8X40AV	32GB DDR4-2133 (2x16GB) Registered RAM 2CPU
G8X33AV	64GB DDR4-2133 (4x16GB) Registered RAM 1CPU
G8X42AV	128GB DDR4-2133 (8x16GB) Registered RAM 2CPU

Optical and Removable Storage	Product #	Offering
	F2D70AV	Slim SuperMulti DVDRW SATA 1st Optical Disk Drive
	G8U64AV	Slim SuperMulti DVDRW SATA 2nd Optical Disk Drive

Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations

600GB SAS 15K rpm 6Gb/s 3.5" HDD

Capacity	600GB
Height	1 in±2.54 cm
Width	Media Diameter 3.5 in±8.9 cm
	Physical Size 4 in±10.17 cm
Interface	SAS
Synchronous Transfer Rate (Maximum)	6.0 Gb/s
Buffer	16 MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 0.2 ms
	Average 3.4 ms
	Full Stroke 6.6 ms
Rotational Speed	15,000 rpm
Logical Blocks	1,172,123,568 - 512 byte blocks
Operating Temperature	50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD

Capacity	300GB
Height	1 in±2.54 cm
Width	Media Diameter 3.5 in±8.9 cm
	Physical Size 4 in±10.17 cm
Interface	SAS
Synchronous Transfer Rate (Maximum)	6Gb/s
Buffer	16MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 0.2 ms
	Average 3.4 ms
	Full Stroke 6.6 ms
Rotational Speed	15,000 rpm
Operating Temperature	50° to 95° F (10° to 35° C)

300GB SAS 10K rpm 6Gb/s 3.5" HDD

Capacity	300GB
Height	0.6 in±1.53 cm
Width	Media Diameter 2.5 in±6.36 cm
	Physical Size 2.75 in±6.99 cm
Interface	SAS 6Gb/s
Synchronous Transfer Rate (Maximum)	Up to 600MB/s
Buffer	64MB
Cache	multi-segmentable cache buffer

	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.4 ms (max)
		Average	3.6 ms
		Full Stroke	7.3 ms
	Rotational Speed	10,000 rpm	
	Logical Blocks	585,937,500	
	Operating Temperature	41° to 131° F (5° to 55° C)	
HP 600GB SAS 10K SFF HDD	Capacity	600GB	
	Height	0.6 in±1.53 cm	
	Width	Media Diameter	2.5 in±6.36 cm
		Physical Size	2.75 in±6.99 cm
	Interface	SAS 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	64MB	
	Cache	multi-segmentable cache buffer	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.4 ms (max)
		Average	3.6 ms
		Full Stroke	7.3 ms
	Rotational Speed	10,000 rpm	
	Logical Blocks	1,172,123,568	
	Operating Temperature	41° to 131° F (5° to 55° C)	
HP 1.2TB SAS 10K SFF HDD	Capacity	1.2TB	
	Height	0.6 in±1.53 cm	
	Width	Media Diameter	2.5 in±6.36 cm
		Physical Size	2.75 in±6.99 cm
	Interface	SAS 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	64MB	
	Cache	multi-segmentable cache buffer	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.18ms (max)
		Average	3.5ms
		Full Stroke	7.17ms
	Rotational Speed	10,000 rpm	
	Logical Blocks	2,344,225,968	
	Operating Temperature	41° to 131° F (5° to 55° C)	

SATA (Serial ATA) Hard	500GB SATA 7200 rpm	Capacity	500GB
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Technical Specifications - Hard Drives

Drives for HP Workstations

6Gb/s 3.5" HDD

Height	1 in±2.5 cm
Width	Media Diameter 3.5 in±8.9 cm
	Physical Size 4 in±10.17 cm
Interface	Serial ATA (6.0Gb/s), NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s
Buffer	16 MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 2 ms
	Average 11 ms
	Full Stroke 21 ms
Rotational Speed	7,200 rpm
Logical Blocks	976,773,168
Operating Temperature	41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity	1TB
Height	1 in±2.54 cm
Width	Media Diameter 3.5 in±8.9 cm
	Physical Size 4 in±10.17 cm
Interface	Serial ATA (6.0Gb/s), NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s
Buffer	64MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 2 ms
	Average 11 ms
	Full Stroke 21 ms
Rotational Speed	7,200 rpm
Operating Temperature	41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity	2.0TB
Height	1 in±2.54 cm
Width	Media Diameter 3.5 in±8.9 cm
	Physical Size 4 in±10.17 cm
Interface	Serial ATA (6.0 Gb/s), NCQ Enabled
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s
Buffer	64MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 1.0 ms
	Average 11 ms
	Full Stroke 18 ms
Rotational Speed	7,200 rpm

Technical Specifications - Hard Drives

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Logical Blocks		3,907,029,168
	Operating Temperature		41° to 131° F (5° to 55° C)
	Capacity	3.0TB	
	Height	1 in±2.54 cm	
	Width	Media Diameter	3.5 in±8.9 cm
		Physical Size	4.0 in±10.17 cm
	Interface	Serial ATA (6.0Gb/s), NCQ enabled	
	Synchronous Transfer Rate (Maximum)	Up to 6.0 Gb/s	
	Buffer	64MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.6 ms
		Average	11 ms
		Full Stroke	Not Specified
	Rotational Speed	7,200 rpm	
	Operating Temperature		41° to 140° F (5° to 60° C)
500GB SATA 7.2K SED SFF HDD	Capacity	500GB	
	Height	0.275 in±0.7 cm	
	Width	Media Diameter	2.5 in±6.36 cm
		Physical Size	2.75 in±6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	32MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	1ms
		Average	4.2ms
		Full Stroke	25ms (typical)
	Rotational Speed	7,200 rpm	
	Operating Temperature		32° to 140° F (0° to 60° C)

Technical Specifications - Hard Drives

HP Solid State Drives (SSDs) for Workstations

HP 128GB SATA 6Gb/s SSD	Capacity	128GB	
	Height	0.28 in±0.7 cm	
	Width	Physical Size	2.5 in±6.36 cm
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequential Read)	
	Operating Temperature	32° to 158° F (0° to 70° C)	
HP 256GB SATA 6Gb/s SSD	Capacity	256GB	
	Height	0.28 in±0.7 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequential Read)	
	Operating Temperature	32° to 158° F (0° to 70° C)	
HP 512GB SATA 6Gb/s SSD	Capacity	512GB	
	Height	0.28 in±0.7 cm	
	Width	Physical Size	2.5 in±6.36 cm
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequential Read)	
	Operating Temperature	32° to 158° F (0° to 70° C)	
HP 1TB SATA 6Gb/s SSD	Capacity	1TB	
	Height	0.28 in±0.7 cm	
	Width	Physical Size	2.5 in±6.36 cm
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequential Read)	
	Operating Temperature	32° to 158° F (0° to 70° C)	
Samsung Enterprise 240GB SATA SSD	Capacity	240GB	
	Width	Physical Size	2.5 in±6.36 cm
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
Samsung Enterprise 480GB SATA SSD	Capacity	480GB	
	Width	Physical Size	2.5 in±6.36 cm
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	

Technical Specifications - Hard Drives

	Intel Pro 1500 180GB SATA SSD	Capacity	180GB	
		Width	Physical Size	2.5 in±6.36 cm
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	600 Mb/s	
		Operating Temperature	32° to 158° F (0° to 70° C)	
PCIe SSDs for HP Workstations	HP Z Turbo Drive 256GB SSD	Capacity	256GB	
		Interface	PCI Express 2.0 x4 electrical x4 physical	
		Operating Temperature	32° to 158° F (0° to 70° C)	
	HP Z Turbo Drive 512GB SSD	Capacity	512GB	
		Interface	PCI Express 2.0 x4 electrical x4 physical	
		Operating Temperature	32° to 158° F (0° to 70° C)	

Technical Specifications - Hard Drive Controllers

LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card	PCI Bus	8 lanes, PCI Express 3.0
	RAID Levels	Offers Integrated RAID (0, 1, 1E and 10)
	PCI Data Burst Transfer Rate	Half Duplex x8, PCIe, 8000 MB/s
	SAS Bandwidth	Half Duplex 600 MB/s per lane
	PCI Card Type	3.3V Add-in card
	PCI Voltage	12 V ± 10%
	PCI Power	9.8W typical, Airflow min 200 LFM
	Bracket	Full height and low profile
	Certification Level	PCI Express 3.0 compliant
	SAS Processor	LSI SAS2308/ Fusion MPT 2.0
	Internal Connectors	One x4 internal mini-SAS (SFF8087)
	External Connectors	One x4 external mini-SAS (SFF8088)
	Maximum Number of SCSI Devices	256 Non-RAID SAS/SATA devices
	LED Indicators	N/A
LSI 9270-8i SAS 6Gb/s ROC RAID Card and iBBU9 Battery Backup Unit	PCI Bus	x8 lane PCIe 3.0 compliant
	RAID Levels	RAID 0, 1, 5, and 6 RAID spans 10, 50 and 60
	PCI Card Type	Low profile, single PCIe slot design with full height bracket.
	PCI Voltage	+3.3V Add-in Card
	PCI Power	+3.3V, +12V
	Certification Level	PCI-Express 3.0
	IO Bus	Eight 6Gb/s and 3Gb/s compatible SAS/SATA ports
	SAS Processor	LSISAS2208 Dual-Core RAID on Chip (ROC)
	Internal Connectors	Two SAS SFF8087 x4 (Mini-SAS)
	External Connectors	None
	Maximum Number of SCSI Devices	Up to 128 SAS and/or SATA hard drives and SSDs NOTE: HP Workstations do not support this many internal drives.
	LED Indicators	Heartbeat LED on card

Technical Specifications - Graphics

NVIDIA NVS 310 512MB Graphics	Form Factor	Low Profile~ 2.7 inches (H) x 5.7 inches (L), Half-Height
	Weight	~142 grams
	Graphics Controller	NVIDIA NVS 310 GPU~GF119-825
	Bus Type	PCI Express x16, 2.0 compliant
	Memory	Size~512MB DDR3
		Clock~875Mhz
		Memory Bandwidth~14GB/s
	Connectors	2 x DisplayPort
	Maximum Resolution	Up to 2560 x 1600 (digital display) per display.
	Image Quality Features	The following video formats are supported~ - MPEG2 - MPEG4 Part 2 Advanced Simple Profile - H.264 SVC codec support - Support for 3D Blu Ray - VC1 - DivX version 3.11 and later - MVC
Display Output	A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.	
	Up to 2 displays in the following configurations~	
	DisplayPort output~	
	• Drives two DisplayPort enabled digital display at resolutions up to 2560 x 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card • Supports 2 monitors up to resolution of 1920 x 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.	
	DVI-D output~	
• Drives two digital display at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors • Drives two digital display at resolutions up to 2560x 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors		
HDMI output~		
• NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 x 1080P at 60 Hz using DisplayPort to HDMI cable adaptors		
VGA display output~		
• Drives two analog display at resolutions up to 1920 x 1200 at 60 Hz		

Technical Specifications - Graphics

		using DisplayPort to VGA cable adaptors
Shading Architecture		Shader Model 5.0
Supported Graphics APIs		DX11, OpenGL 4.1
Available Graphics Drivers		Windows 8 Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site— http://welcome.hp.com/country/us/en/support.html
		SUSE Linux Enterprise drivers may also be obtained from— ftp://download.nvidia.com/novell or http://www.nvidia.com
Power Consumption		19.5 Watts
Note		1. The thermal solution used on this card is an active fan heatsink. 2. Factory configured NVS 310 graphics card have no cable adapters included. Adapters must be ordered separately. 3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

NVIDIA NVS 315 1GB Graphics (for HP Workstations)	Form Factor	Low Profile— 2.713 inches in height × 5.7 inches in length Weight—~142 grams
	Graphics Controller	NVIDIA NVS 315 (using GF119-825 GPU) Number of Cores—48 CUDA cores Max. Power—19.3W Cooling Solution—Active fan heatsink
	Bus Type	PCI Express x16, 2.0 compliant
	Memory	Size—1GB DDR3 Clock—875Mhz Memory Bandwidth—14GB/s
	Connectors	DMS-59 output Cables included— - For CTO—DMS-59 to DVI cable - For AMO—DMS-59 to DVI cable and DMS-59 to VGA cable
	Maximum Resolution	Maximum number of displays supported—2 Maximum Resolution Support— - DMS-59 to VGA—2048 x 1536 @ 85Hz - DMS-59 to DVI—1980 x 1200 @ 60Hz - DMS-59 to DP—2560 x 1600 @ 60Hz
	Image Quality Features	See Display Output section. The following video formats are supported— - MPEG2 - MPEG4 Part 2 Advanced Simple Profile - H.264 SVC codec support - Support for 3D Blu Ray - VC1

Technical Specifications - Graphics

	- DivX version 3.11 or later
	A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.
Display Output	Up to 2 displays using one of the following DMS-59 cables¹ DMS-59 to DVI DMS-59 to VGA DMS-59 to DP DisplayPort output² • Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter. DVI-D output² • Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor VGA display output² • Drives two analog display at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.
Shading Architecture	Shader Model 5.0
Supported Graphics APIs	DX11, OpenGL 4.3
Available Graphics Drivers	Windows 8 Microsoft Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site³ http://welcome.hp.com/country/us/en/support.html SUSE Linux Enterprise drivers may also be obtained from³ ftp://download.nvidia.com/novell or http://www.nvidia.com
Notes	1. The thermal solution used on this card is an active fan heatsink. 2. Factory configured graphics card includes DMS-59 to DVI cable. 3. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA cables (one each).

NVIDIA NVS 510 2GB Graphics

Form Factor	Low Profile, 2.713 inches × 6.3 inches, single slot
Graphics Controller	NVS 510 GPU Core Clock⁴797 Mhz Memory Clock⁴891 Mhz CUDA Cores⁴192
Bus Type	PCI Express x16, Generation 2.0



Technical Specifications - Graphics

Memory	2GB DDR3
Connectors	Four mini-DisplayPort. Four mini-DisplayPort to DisplayPort adapters included. (DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories)
Maximum Resolution	Mini-DisplayPort connectors support ultra-high-resolution panels (up to 3840 x 2160 @ 60Hz)
	NOTE: This card supports up to four displays. For Windows XP, only 2 active displays are supported.
Image Quality Features	10-bit internal display processing, including hardware support for 10-bit scan-out
Display Output	DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2) support.
	Digital Display Support
	DisplayPort Output
	• Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card. • DisplayPort Multi-Stream Topology (MST) Technology—Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.
	DVI-D Output
	• Drives four digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors. • Drives four digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.
	HDMI Output
	• The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.
	Analog Display Support
	VGA display output
	• Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors.
Supported Graphics APIs	Full Microsoft DirectX 11, Shader Model 5.0 support Full OpenGL 4.3 support
Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Technical Specifications - Graphics

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation
SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web site-

<http://welcome.hp.com/country/us/en/support.html>

Heatsink cooler design is active.

Note

Graphics Cable Adapters Note

Graphics Cable Adapter option choice is available starting Feb 1 2013 for the following graphics cards-

NVS 310, Quadro 410, Quadro K5000, FirePro V3900, FirePro W7000

New Graphics Cards introduced after Feb 1 2013 will be eligible for choosing Graphics Cable Adapters, unless otherwise specified.

No cable choice for NVS 300, NVS 510.

Maximum number of cables allowed is 8.

NVIDIA Quadro K420 1GB Graphics

Form Factor

Low Profile-
2.713 inches × 6.3 inches, single slot

Graphics Controller

NVIDIA Quadro K420
GPU-GK107

Bus Type

PCI Express x16, 2.0 compliant

Memory

Size-1GB DDR3
Clock-891MHz
Memory Bandwidth-29GB/s

Connectors

One dual-link DVI-I connector
One DisplayPort connector

Maximum Resolution

VGA (via adapter cable)-

- 2048 × 1536 × 32 bpp at 85 Hz

Dual-link DVI

- 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

- 920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

- 3840 × 2160 × 30 bpp at 60 Hz

RAMDAC

400 MHz integrated RAMDAC

Display Output

Maximum number of displays supported-2

Shading Architecture

Shader Model 5.0

Supported Graphics APIs

DX11, OpenGL 4.4
Programming support for CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Python, and Fortran

Technical Specifications - Graphics

Available Graphics Drivers	Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7 Linux
Notes	1. Factory configured Quadro K420 does not include any video adapters. Adapters must be ordered separately. 2. Option kit Quadro K420 includes one DP to DVI-D adapter.

NVIDIA Quadro K620 2GB Graphics	Form Factor	2.7138H x 6.38L Single Slot, Low Profile Full Height Profile bracket installed Low Profile bracket included Weight=133 grams
	Graphics Controller	NVIDIA Quadro K620 Graphics Card GM107 GPU 384 CUDA cores Max Power=45 Watts
	Bus Type	PCI Express 2.0 x16
	Memory	2 GB GDDR3, 900 MHz 128-bit memory I/O path 29 GB/s memory bandwidth
	Connectors	1 DL-DVI(I) output, 1 DisplayPort output Factory Configured=No video cable adapter included Option Kit=One DP-to-DVI adapter included with card
	Maximum Resolution	Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories. DisplayPort 1.2= - up to 4096x2160 x 30 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) Dual Link DVI(I) output= - up to 2560 x 1600 x 32 bpp @ 60Hz Single Link-DVI(I) output= - up to 1920 x 1200 x 32 bpp @ 60Hz
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	1 Dual-link DVI-I connector 1 Display Port connector
	Shading Architecture	Full Microsoft DirectX 11.1 Shader Model 5.0
	Supported Graphics APIs	OpenGL 4.4 DirectX 11.1 API support includes= CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
	Available Graphics Drivers	Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7 Linux

Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP support Web site=

<http://welcome.hp.com/country/us/en/support.html>

Notes

1. Factory configured Quadro K620 does not include a video cable adapter. Video cable adapters must be ordered separately.
2. Quadro K620 offered as an Option Kit (AMO) includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

NVIDIA Quadro K2200 4 GB Graphics

Form Factor

4.38" H x 7.97" L
Single Slot, Full Height

Weight

240 grams

Graphics Controller

NVIDIA Quadro K2200 Graphics Card
GM107 GPU
640 CUDA cores
Max Power=67.7 Watts

Bus Type

PCI Express 2.0 x16

Memory

4 GB GDDR5, 2500 Mhz
128-bit memory I/O path
80 GB/s memory bandwidth

Connectors

1 DL-DVI(I) output, 2 DisplayPort outputs
Factory Configured Option=No video cable adapter included
Option Kit=One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as accessories

Maximum Resolution

DisplayPort=

- up to 4096 x 2160 x 30 bpp @ 60Hz
- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output=

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline
10-bit scan-out support

Display Output

VGA=

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters
- 400 MHz integrated RAMDAC
- Max resolution=2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I)=

- Max resolution=2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I)=

- Max resolution=1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort=

- Supports HBR2 and MST
- Max resolution=4096 x 2160 x 30 bpp @ 60 Hz (only one monitor can be



Technical Specifications - Graphics

- connected to a Quadro K2200 DisplayPort connector at this resolution)
- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K2200 DisplayPort connector=4 with maximum resolution of 1920 x 1200

Shading Architecture	Maximum number of monitors across all available Quadro K2200 outputs is 4.
Supported Graphics APIs	Full Microsoft DirectX 11.1 Shader Model 5.0
Available Graphics Drivers	OpenGL 4.4 DirectX 11.1 API support includes= CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7 Linux
Notes	HP qualified drivers may be preloaded or available from the HP support Web site= http://welcome.hp.com/country/us/en/support.html 1. Quadro K2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro K2200 offered as an Option Kit includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately. 3. A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained DisplayPort 1.2 displays or a DisplayPort 1.2 hub device. 4. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K2200 DisplayPort output.

AMD FirePro W2100 2GB Graphics	Form Factor	Low Profile, half length (full-height bracket included)
	Graphics Controller	AMD FirePro™ W2100 professional graphics Power<50W Cooling=Active
	Bus Type	PCI Express® x8, Generation 3.0
	Memory	2GB DDR3 memory Memory Bandwidth=14.4 GB/s
	Connectors	2x Display Port 1.2 connectors
		Factory Configured=No video cable adapter included Option Kit=One DP-to-DVI adapter included with card
		Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	DisplayPort 1.2= • up to 4096x2160 x 30 bpp @ 60Hz Dual Link DVI(I) (requires adapter cable)= • up to 2560 x 1600 x 32 bpp @ 60Hz

Technical Specifications - Graphics

	Single Link-DVI(I)(requires adapter)=
	up to 1920 x 1200 x 32 bpp @ 60Hz
	VGA(requires adapter)=
	up to 1920 x 1200 x 32 bpp @ 60Hz
Display Output	2 x DisplayPort® 1.2
Shading Architecture	Shader Model 5.0
Supported Graphics APIs	OpenCL™ 1.2, DirectX® 11 and OpenGL 4.4
Available Graphics Drivers	Windows 8.1 (64-bit and 32-bit) Windows 7 (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) SUSE Linux Enterprise Desktop 11(64-bit and 32-bit) Ubuntu HP qualified drivers may be preloaded or available from the HP support Web site= http://welcome.hp.com/country/us/en/support.html
Notes	Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be required. See www.amd.com/firepro for details

NVIDIA Quadro K4200 4GB Graphics	Form Factor	4.3768H x 9.58L Single Slot, Full Height
	Weight	~458 grams (without extender)
	Graphics Controller	NVIDIA Quadro K4200 Graphics Card Kepler GK104 GPU 1344 CUDA cores Max Power=108 Watts
	Bus Type	PCI Express 2.0 x16
	Memory	4 GB GDDR5, 2700 MHz 256-bit memory I/O path 173 GB/s memory bandwidth
	Connectors	1 DL-DVI(I) output, 2 DisplayPort outputs CTO=No video cable adapter included AMO=One DP-to-DVI adapter included with card
	Maximum Resolution	Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as accessories DisplayPort= - up to 3840 x 2160 x 30 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)
	Image Quality Features	DL-DVI(I) output= - up to 2560 x 1600 x 32 bpp @ 60Hz 10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	VGA=

Technical Specifications - Graphics

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters
- 400 MHz integrated RAMDAC
- Max resolution=2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I)=

- Max resolution=2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I)=

- Max resolution=1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort=

- Supports HBR2 and MST
- Max resolution=3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K4200 DisplayPort connector at this resolution)
- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K4200 DisplayPort connector=4 with maximum resolution of 1920 x 1200

HDMI=

- Requires use of DP-to-HDMI cable
- Max Resolution=1920 x 1080 x 32 bpp @ 60Hz

Maximum number of monitors across all available Quadro K4200 outputs is 4.

Shading Architecture

Full Microsoft DirectX 11 Shader Model 5.0

Supported Graphics APIs

OpenGL 4.4

DirectX 11.1

API support includes=

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Microsoft Windows 8.1

Microsoft Windows 8

Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support Web site=

<http://welcome.hp.com/country/us/en/support.html>

Notes

1. Quadro K4200 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
2. Quadro K4200 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
3. A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained DisplayPort 1.2 displays or a DisplayPort 1.2 hub device.
4. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K4200 DisplayPort output.

NVIDIA Quadro K5200 8GB Form Factor Graphics

4.3768H x 10.58L
Dual Slot



Technical Specifications - Graphics

Weight	~880 grams
Graphics Controller	NVIDIA Quadro K5200 GK 110 GPU 2304 CUDA cores Max Power~150 Watts
Bus Type	PCI Express 3.0 x16
Memory	8GB GDDR5 256-bit memory I/O path 192 GB/s memory bandwidth
Connectors	DVI-I (1), DVI-D (1), DP (2), Factory configured option~No adapter included with card. Option Kit~No adaptor included with card. DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-Link DVI adapters available as accessories.
Image Quality Features	• DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support • NVIDIA 3D Vision™ technology
Display Output	400 MHz integrated RAMDAC • Maximum resolution over VGA (through DVI to VGA cable)~2048 × 1536 × 32 bpp at 85 Hz Dual-link internal TMDS (DVI 1.0) • Maximum resolution over digital port (single GPU and SLI mode)~2560 × 1600 × 32 bpp at 60 Hz (reduced blanking) Single-link internal TMDS (DVI 1.0) • Maximum resolution over digital port (single GPU and SLI mode)~1920 × 1200 × 32 bpp at 60 Hz (reduced blanking) DisplayPort with MST and HBR2. • Maximum resolution~4096 × 2160 × 30 bpp at 60Hz • Maximum resolution~2560 x 1600 x 30bpp at 120Hz HDMI • Maximum resolution~1920 × 1080 × 32 bpp at 60Hz
Shading Architecture	Shader Model 5.0
Supported Graphics APIs	OpenGL 4.4 DirectX 11 API support for NVIDIA's CUDA™ C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
Available Graphics Drivers	Windows 8 Windows 7 Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation (64-bit) SUSE Linux Enterprise Desktop 11 SP3(64-bit and 32-bit)

Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP support Web site—

<http://welcome.hp.com/country/us/en/support.html>

Notes

1. NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K5200 to enable direct mapping of GPU to Virtual Machine.
2. No display output adapter included.

NVIDIA Quadro K6000 12GB Graphics

Form Factor

4.3768H x 10.58L

Dual Slot

Power—234 Watts

Weight

~880 grams

Graphics Controller

NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU

Core Count—2880

Base Clock—797 MHz

Boost Clock—902 MHz

Bus Type

PCI Express 3.0 x16

Memory

12GB GDDR5

384-bit memory I/O path

288 GB/s memory bandwidth

ECC Memory

Connectors

DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN connector.

Factory configured option—No adapter included with card.

Option Kit—No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-Link DVI adapters available as accessories.

Image Quality Features

- DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support
- NVIDIA 3D Vision™ technology
- NVIDIA Premium Mosaic and nView

Display Output

400 MHz integrated RAMDAC

- Maximum resolution over VGA (through DVI to VGA cable)—2048 × 1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

- Maximum resolution over digital port (single GPU and SLI mode)—2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

- Maximum resolution over digital port (single GPU and SLI mode)—1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

- Maximum resolution—3840 × 2160 × 36 bpp at 60Hz

HDMI



Technical Specifications - Graphics

	Maximum resolution—1920 × 1080 × 32 bpp at 60Hz
Shading Architecture	Shader Model 5.0 Full IEEE 764-2008 32-bit and 64-bit precision
Supported Graphics APIs	Full OpenGL 4.3 Full DirectX 11 CUDA API support includes— CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
Available Graphics Drivers	Windows 8 Windows 7 Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site— http://welcome.hp.com/country/us/en/support.html Novell SUSE Linux Enterprise drivers may also be obtained from— ftp://download.nvidia.com/novell or http://www.nvidia.com
Notes	- NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K6000 to enable direct mapping of GPU to Virtual Machine. - No display output adapter included.

Technical Specifications - High Performance GPU Computing

NVIDIA Tesla K40 Workstation Compute Processor	Form Factor	Size=4.376 inches by 10.5 inches Slots=Dual Slot Power Connectors=One 6-pin and one 8-pin
	Weight	~826 grams
	System Interface	PCI Express Gen3 ×16
	Video Outputs	None.
	Memory	12GB GDDR5, memory path=384-bit memory clock=3Ghz
	Peak Memory Bandwidth	288 GB/s
	Supported APIs	CUDA, OpenACC, OpenCL 1.2 API support includes= C, C++, Java, Python, and Fortran
	Supported Operating Systems	Windows 8 (64-bit) Genuine Windows 7 Professional (64-bit) Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit) SUSE Linux Enterprise Desktop 11 (64-bit)
		HP qualified drivers may be preloaded or available from the HP support Web site= http://welcome.hp.com/country/us/en/support.html
		Novell SUSE Linux Enterprise drivers may also be obtained from= ftp://download.nvidia.com/novell or http://www.nvidia.com
NVIDIA Tesla K20c Compute Processor	Processor Cores	GK110B GPU Base Clock=745 MHz Boost Clock=up to 875 MHz 2888 CUDA cores
	Power Consumption	~235 Watts
		Note 1 =A 1125W PSU is required for any K40 configuration on the Z820
	Form Factor	4.376 inches by 10.5 inches Dual Slot
	System Interface	PCI Express Gen2 ×16
	Video Outputs	None.
	Memory	5GB GDDR5, 320-bit memory path
	Peak Memory Bandwidth	208 GB/s (with ECC off)
	Supported APIs	CUDA and OpenACC API support includes= CUDA C, CUDA C++, Java, Python, and Fortran
	Supported Operating Systems	Windows 8 (64-bit) Genuine Windows 7 Professional (64-bit) Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit) SUSE Linux Enterprise Desktop 11 (64-bit)
		HP qualified drivers may be preloaded or available from the HP support Web site= http://welcome.hp.com/country/us/en/support.html

Technical Specifications - High Performance GPU Computing

Processor Cores

Power Consumption

Novell SUSE Linux Enterprise drivers may also be obtained from <ftp://download.nvidia.com/novell> or <http://www.nvidia.com>

GK110 GPU, 706 MHz clock
2496 CUDA cores

~225 Watts

Note 1-A 1125W PSU is required for any K20 configuration on the Z820

Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim SuperMulti DVD Writer	Description	9.5mm height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA/ATAPI
	Dimensions (WxHxD)	128 x 9.5 x 127mm
	Supported Media Types	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW
	Disc Capacity	DVD-ROM 8.5 GB DL or 4.7 GB standard Full Stroke DVD < 200 ms (seek) Full Stroke CD < 200 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read CD-ROM, CD-R Up to 24X CD-RW Up to 24X DVD ROM Read DVD-RAM Up to 8X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Power	Source SATA DC power receptacle DC Power Requirements 5 VDC $\pm$ 5%-100 mV ripple p-p DC Current 5 VDC -< 800 mA typical, <1600 mA maximum
	Operating Environmental (all conditions non-condensing)	Temperature 41° to 122° F (5° to 50° C) Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)
	Operating Systems Supported	Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11
	Kit Contents	No driver is required for this device. Native support is provided by the operating system. 9.5mm Slim SuperMulti DVD Writer, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide

Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim DVD-ROM Drive	Description	9.5mm height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA/ATAPI
	Dimensions (WxHxD)	128 x 9.5 x 127mm
	Disc Capacity	DVD-ROM Single layer—Up to 4.7 GB Double layer—Up to 8.5 GB
	Access Times	DVD-ROM Single Layer CD-ROM Mode 1 Full Stroke DVD Full Stroke CD < 110 ms (typical) < 110 ms (typical) < 230 ms (typical) < 220 ms (typical)
	Power	Source DC Power Requirements DC Current SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p 5 VDC —< 800 mA typical, <1600 mA maximum
	Operating Environmental (all conditions non-condensing)	Temperature Relative Humidity Maximum Wet Bulb Temperature 41° to 122° F (5° to 50° C) 10% to 80% 84° F (29° C)
	Operating Systems Supported	Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11
	Kit Contents	No driver is required for this device. Native support is provided by the operating system. 9.5mm Slim DVD-ROM Drive, 5.25" BDD Bay adapter/carrier, slim SATA data/power cable, installation guide
HP 9.5mm Slim BDXL Blu-Ray Writer	Description	9.5mm height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA/ATAPI
	Dimensions (WxHxD)	128 x 9.5 x 127mm
	Supported Media Types	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Technical Specifications - Optical and Removable Storage

Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
	Blu-ray	25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL)
	Full Stroke DVD	< 230 ms (seek)
	Full Stroke CD	< 220 ms (seek)
	Blu-ray	< 230 ms (seek) (Full Stroke Blu-ray)
	Startup Time	(Time to drive ready from tray loading)
		BD-ROM (SL/DL) 25S / 28S
		BD-R (SL/DL) 25S / 28S
		BD-RE (SL/DL) 25S / 28S
		DVD-ROM (SL/DL) 18S / 18S
Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
	DVD ROM Read	DVD-RAM Up to 8X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Blu-ray	BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X
Power	Source	SATA DC power receptacle
	DC Power Requirements	5 VDC $\pm$ 5%-100 mV ripple p-p
	DC Current	5 VDC -900 mA typical, 2000mA maximum
Operating Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature	84° F (29° C)
Operating Systems Supported	Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*.	
	Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11	

Technical Specifications - Optical and Removable Storage

	Kit Contents	No driver is required for this device. Native support is provided by the operating system. 9.5mm Slim BDXL Blu-Ray Writer, 5.25" HDD Bay adapter/carrier, slim SATA data/power cable, installation guide As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.
HP DX115 Removable Drive Enclosure	Interface Type	Compatible with SAS or SATA controllers. Offers 6Gb/s performance when used with 6Gb/s HDDs.
	Dimensions (WxHxD)	147.6mm W x 41.1mm H x 205mm D (5.81" W x 1.62" H x 8.08" D)
	Weight	Frame and Carrier=1.73 kg (3.8 lbs.) Carrier=0.45 kg (1 lbs.)
HP 15-in-1 Media Card Reader	Description	Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports MS 4-bit parallel transfer mode Supports MS-PRO 4-bit parallel transfer mode Supports MS PRO-HG Duo 4-bit parallel transfer mode Supports SD 4-bit parallel transfer mode Supports UHS-104 SD 4-bit card (version 3.0) Supports CF v6.0 with PIO mode 6 and Ultra DMA 7 mode
	Interface Type	USB 3.0 High-speed interface NOTE: If there is a USB2 connection, USB2 transfer speeds are supported.
	Dimensions (WxHxD)	4.9 x 4 x 1 in (124.5 x 101.6 x 25.4 mm) Fits conveniently in the 5.25" drive bay.
	Supported Media Types	CompactFlash Type I CompactFlash Type II Microdrive Secure Digital Card (SD) Secure Digital High Capacity (SDHC) SD Extended Capacity Memory Card (SDXC) SD Ultra High Speed II (SD UHSII) Memory Stick Memory Stick Select Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO) Memory Stick PRO Duo (MS PRO Duo) Memory Stick PRO-HG Duo MagicGate Memory Stick (MG) MagicGate Memory Stick Duo
		These additional media types are supported with a card adapter. Memory Stick Micro (M2) miniSD miniSD High Capacity Micro SD Memory Card (MicroSD)

Technical Specifications - Optical and Removable Storage

	Micro SD High Capacity Memory Card (MicroSDHC)
	Test Parameters/Conditions - Power applied, unit operating on system ±5%
Operating Systems Supported	Windows 8 Pro (64-bit)* Windows 8.1 (64-bit)* Windows 8 (64-bit)* Windows 7 Ultimate (32-bit)** Windows 7 Ultimate (64-bit)** Windows 7 Professional (32-bit)** Windows 7 Professional (64-bit)** Windows 7 Home Basic** Windows 7 Home Premium (32-bit)** Windows 7 Home Premium (64-bit)** Windows Vista Business 64 Windows Vista Business 32 Windows Vista Home Basic 32 Windows XP Professional Windows XP Home 32
	No driver is required for this device. Native support is provided by the operating system. Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com. Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.
Kit Contents	Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security Software and Documentation CD
Approvals	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT
Weight	0.35 lbs. (0.16 kg)

Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCIe Card	Data Transfer Rate	Supports up to 800 Mbps
	Devices Supported	IEEE-1394 compliant devices
	Bus Type	PCIe card full height PCIe slots
	Ports	Two IEEE-1394b external 9-Pin connectors (Rear)
	Internal Connectors	One 10-Pin header Custom Connector
	System Requirements	Windows 8.1 64-bit, Windows 7 Professional 32-bit and 64-bit, SLED 11 and RHEL 6. Intel i5 series or higher processor, min 2GB of RAM, 20GB Hard Drive, CD-ROM drive, built in sound system, Available PCIe slot.
	Temperature – Operating	50° to 131° F (10° to 55° C)
	Temperature – Storage	–22° to 140° F (–30° to 60° C)
	Relative Humidity – Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Windows 8.1 64-bit, Windows 7 Professional 32-bit and 64-bit
HP Thunderbolt-2 PCIe 1-port I/O Card	Data Transfer Rate	Supports up to 20 Gb/s (20,000 Mb/s)
	Devices Supported	Thunderbolt™ certified devices
	Bus Type	PCIe card, full or half height PCIe slots
	Ports	One Thunderbolt™ 2 external 20-Pin output connectors (Rear) One full size DisplayPort input connector (Rear)
	Internal Connectors	One 5-Pin header connector
	System Requirements	Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel i5 series or higher processor, 4-GB RAM, 20-GB Hard Drive, available PCIe slot.
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	–22° to 140° F (–30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.
	Kit Contents	HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height bracket, DisplayPort to DisplayPort cable, internal header cables (2), user documentation and warranty card.

Technical Specifications - Networking and Communications

Integrated Intel I218LM PCIe GbE Controller	Connector	RJ-45 (motherboard integration)
	Controller	Intel I218LM GbE platform LAN connect networking controller
	Memory	3 KB FIFO packet buffer memory (both Tx and Rx)
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.1as, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3x, 802.3z
	Bus Architecture	PCI Express 1.1 (x1) and SMBus
	Data Path Width	X1, 250 MB/s, Bi-directional interface
	Data Transfer Mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power Requirement	Requires 3.3V only (integrated regulators)
	Boot ROM Support	Yes
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Management Capabilities	WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, Advanced cable diagnostics AMT 9.1 support, vPro compliant
HP X520 10GbE Dual Port Adapter	Hardware Certifications	FCC B, UL, CE, VCCI, BSMI, CTICK, KCC
HP 10GbE SFP+ SR Transceiver	Operating Temperature	0°C to 45°C (32°F to 113°F)
	Operating Humidity	0% to 85%, noncondensing
	Dimensions (H x W x D)	0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm)

Technical Specifications - Networking and Communications

HP 361T PCIe Dual Port Gigabit NIC	Connector	Two RJ-45
	Controller	Intel® Ethernet I350 Controller
	Data Rates Supported	10/100/1000 Mbps, Half- and full-duplex
	Compliance	802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q, 802.3az, IEEE 1588 PCIe v2.0 standard RoHS (6 of 6) FCC (U.S. only) Class B DOC (Canada) Class B CE EN 55024, EN55022 Class B VCCI Class II UL 1950 CSA 950 EN 60950 CE ACPI 1.1a Microsoft WHQL (Windows Hardware Quality Labs)
	Data Path Width	Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express slots
	Power Requirement	4.1W idle without EEE link partner 3.2W idle with EEE link partner 4.2W maximum
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s
	Operating Temperature	32° to 131°F (0° to 55° C)
	Operating Humidity	10% to 95% non-condensing
	Dimensions (H x W x D)	5.3 x 2.5 in (13.50 cm x 6.4 cm) (without brackets)
	Operating System Driver Support	Windows 7 Professional 32-bit and 64-bit. Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation Novell SLED 10 & SLED 11
	Kit Contents	HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height bracket attached to it (the low profile bracket is included in the clamshell that the PCA ships in) Product Warranty statement and the Quick Install Card (QIC).

Technical Specifications - Networking and Communications

Intel 7260 802.11 a/b/g/n	Operating Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
PCIe WLAN NIC		
	Dimensions (H x W x D)	Native HMC=26.8 x 30.0 x 2.4 mm Carrier Card Assembly 3.3 x 4.7 in (84 x 119 mm)
	Kit Contents	PCIe x1 card with full height bracket, rf antenna, antenna cable, separate low profile bracket, software CD and warranty.
	Notes	1. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista. 2. Check latest software/driver release for updates on supported security features. 3. Maximum output power may vary by country according to local regulations. 4. In Power Save Polling mode and on battery power. 5. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Summary of Changes

Date	Version History	Action	Description of Change
October 1, 2014	From Version 1 to 2	Added	Cyberlink Power2Go on supported components=software, Foxit PhantomPDF Express to supported components=software, note to supported components=memory, Optical drives, DVD, BD-XL specs
		Changed	Processor table with corrected turbo specs for E5-1660v3, Declared Noise Emissions section, stable & consistent offerings,system technical specifications=system board, supported components=optical and removable storage, supported components=graphics, Zero-ed out Noise Emissions
		Removed	Cyberlink MediaSuitefrom supported components=software

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